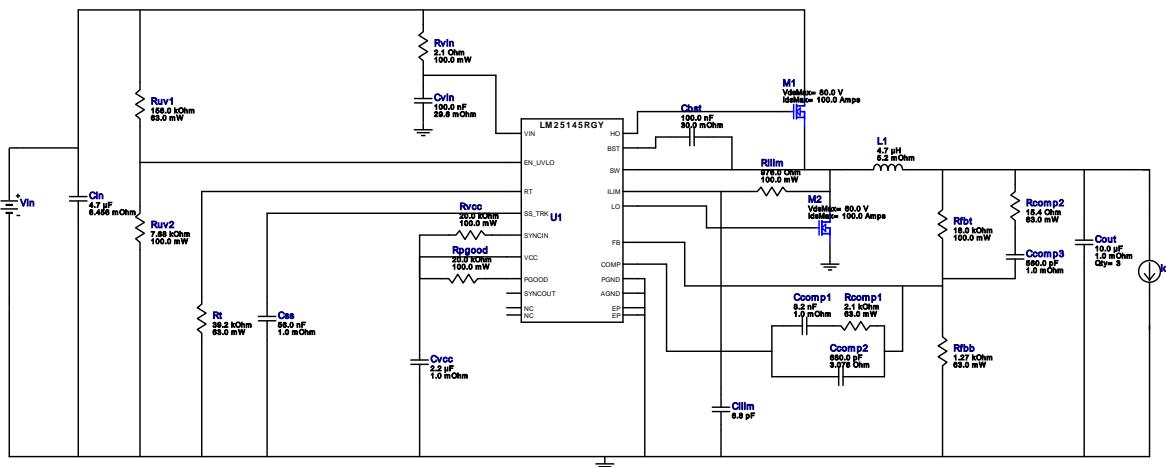


WEBENCH® Design Report

Design : 8 LM25145RGYR
LM25145RGYR 32V-36V to 12.00V @ 15A

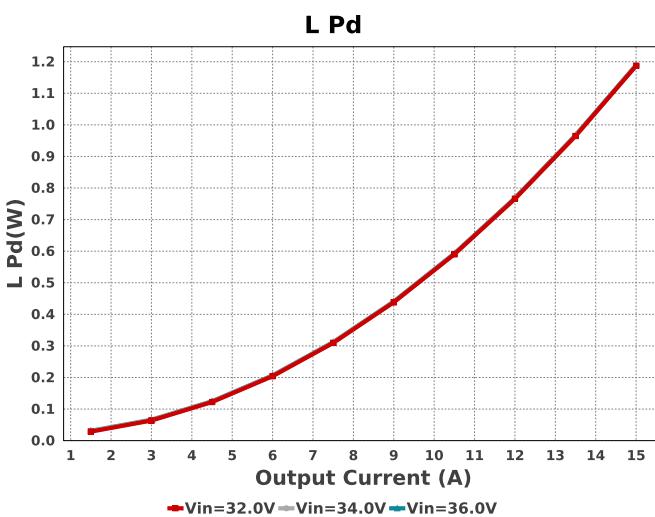
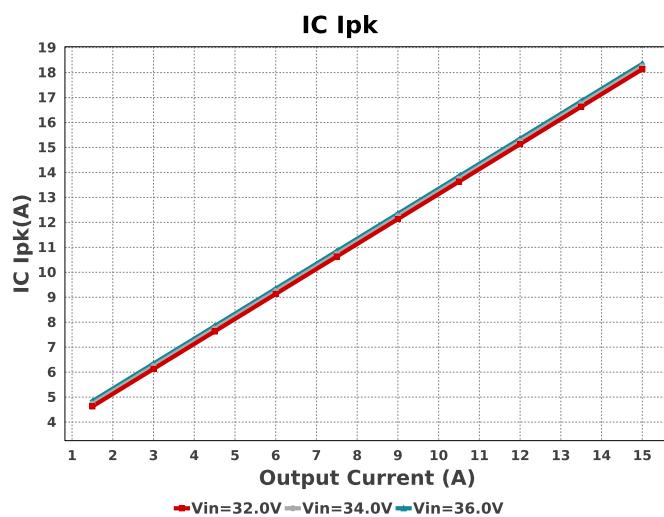
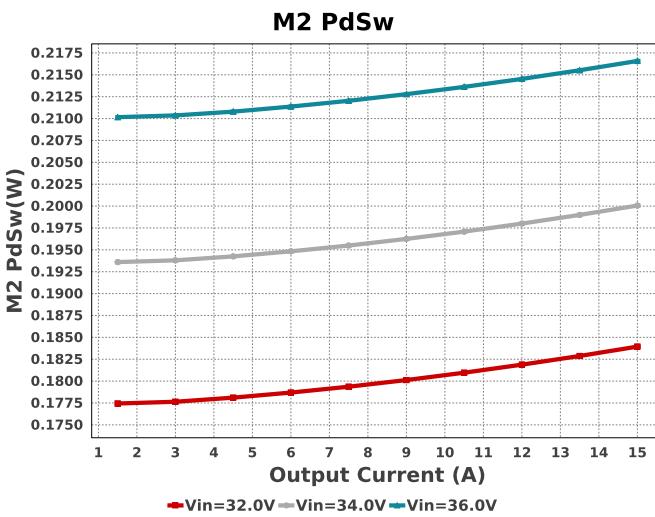
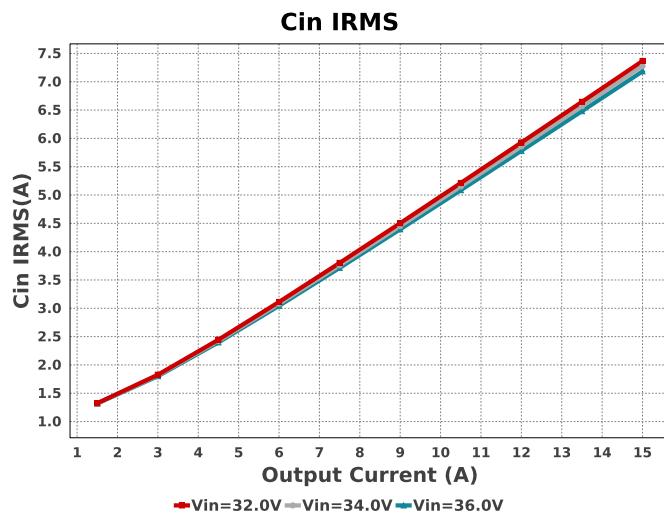
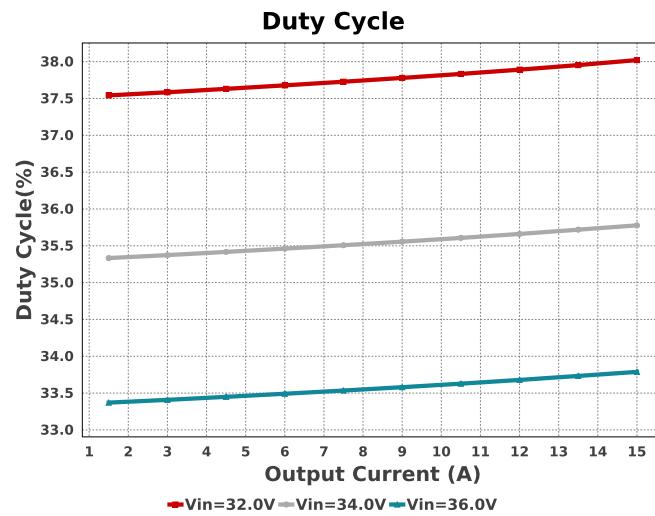
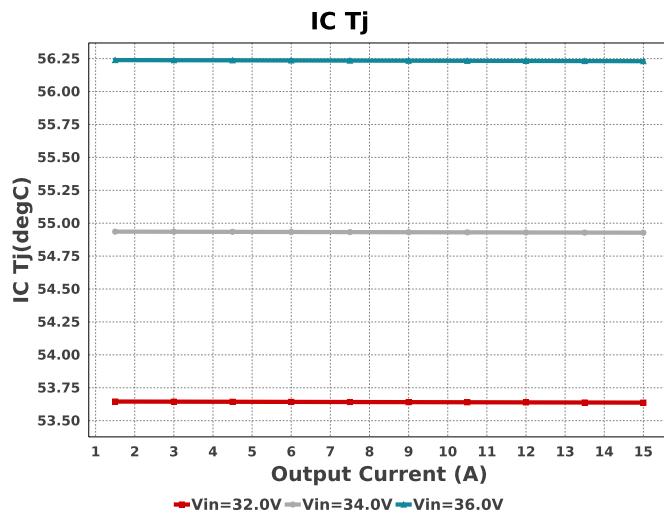
VinMin = 32.0V
VinMax = 36.0V
Vout = 12.0V
Iout = 15.0A

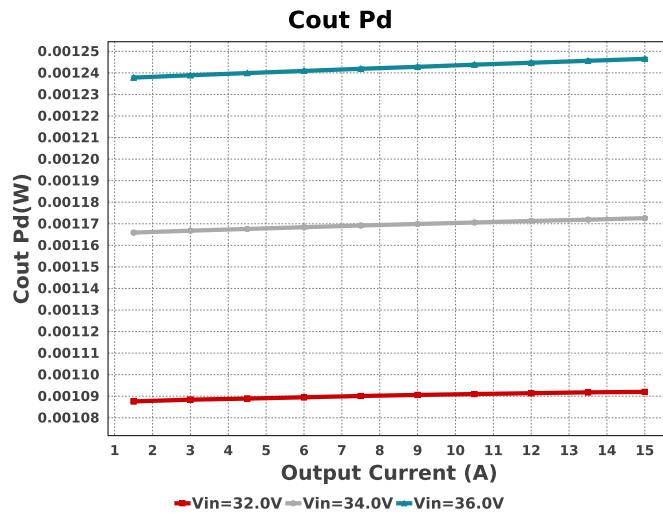
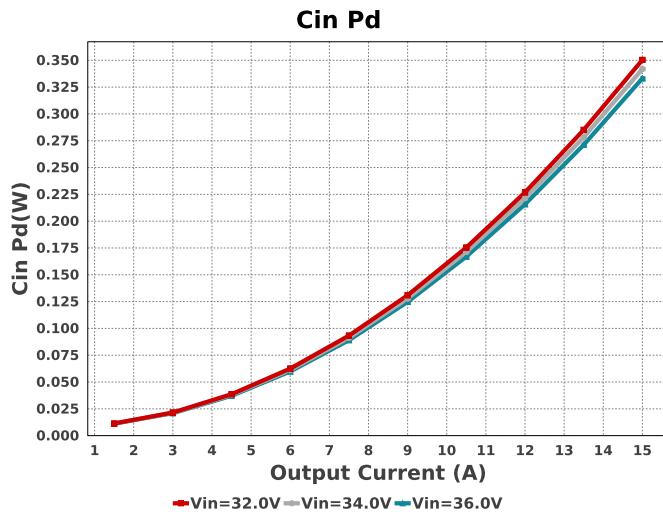
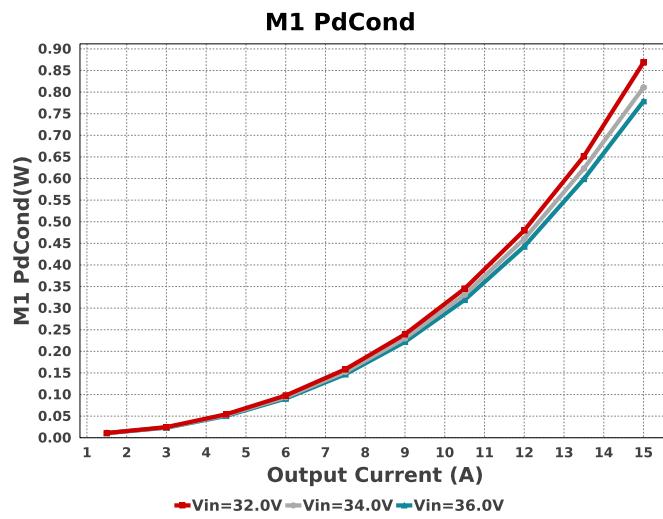
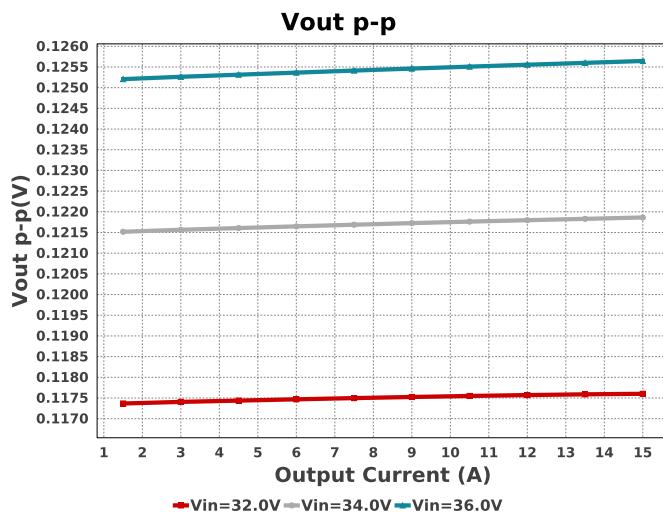
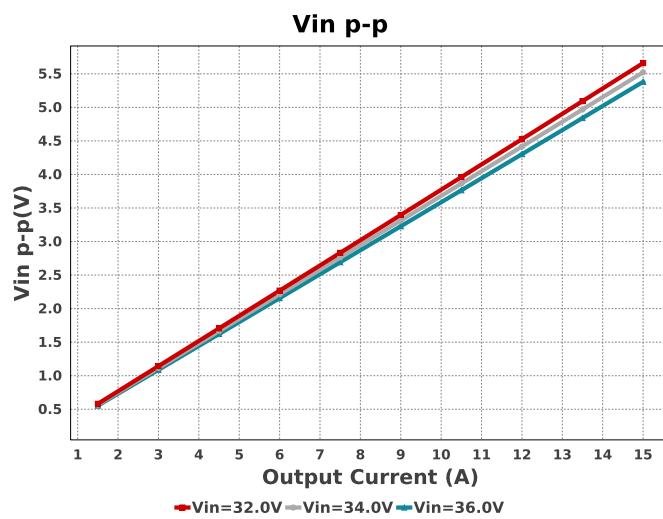
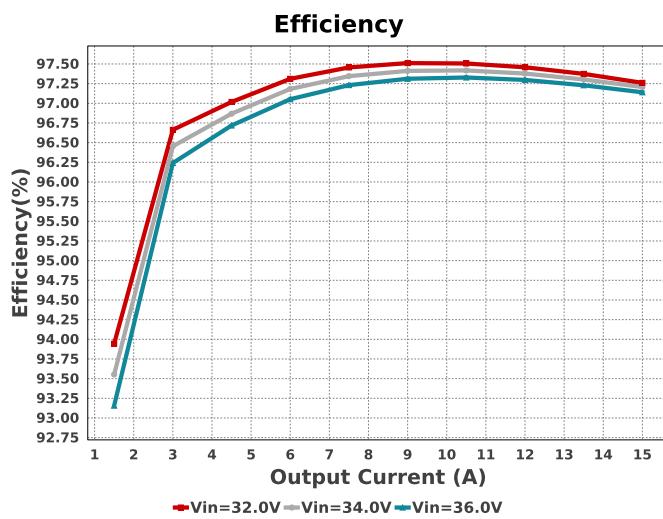
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Topology = Buck
Created = 2025-06-16 07:53:30.977
BOM Cost = \$5.39
BOM Count = 27
Total Pd = 5.3W

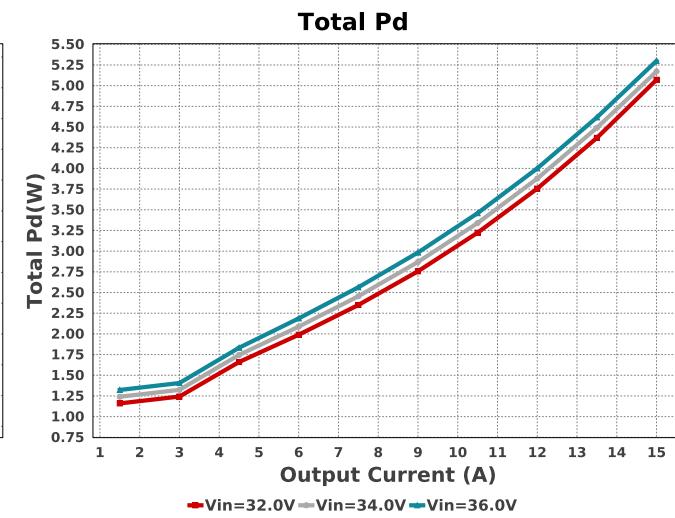
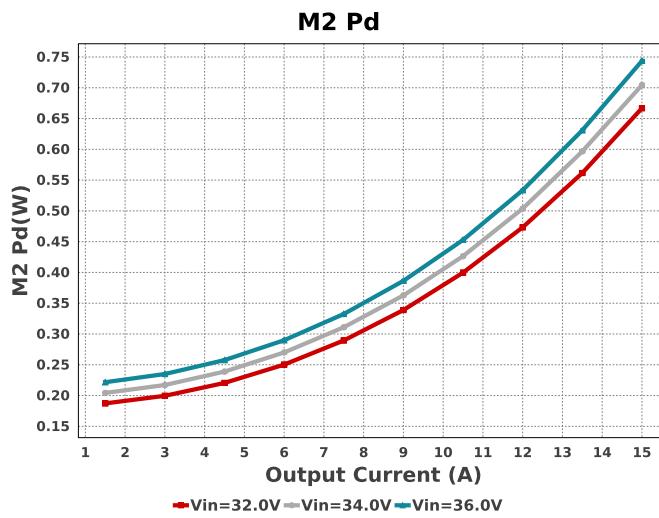
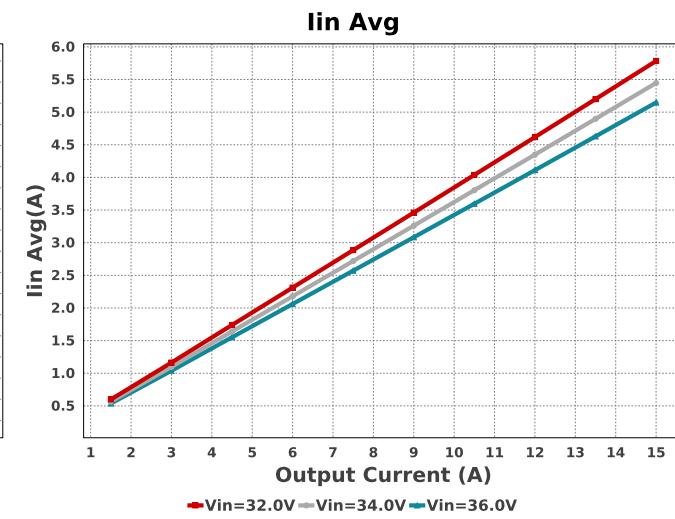
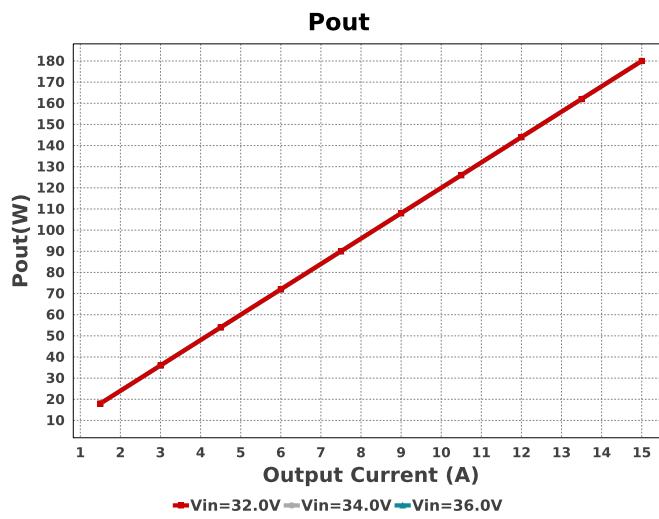
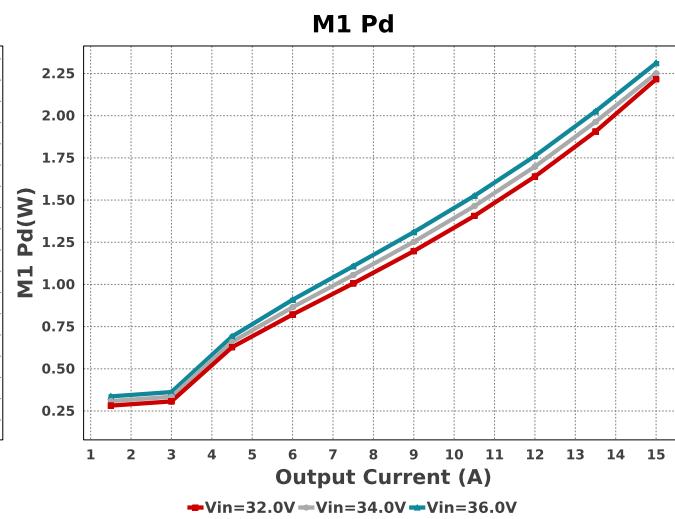
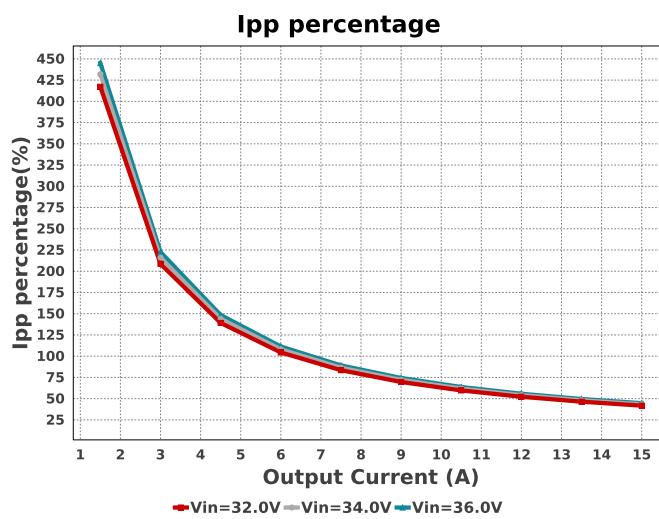

Electrical BOM

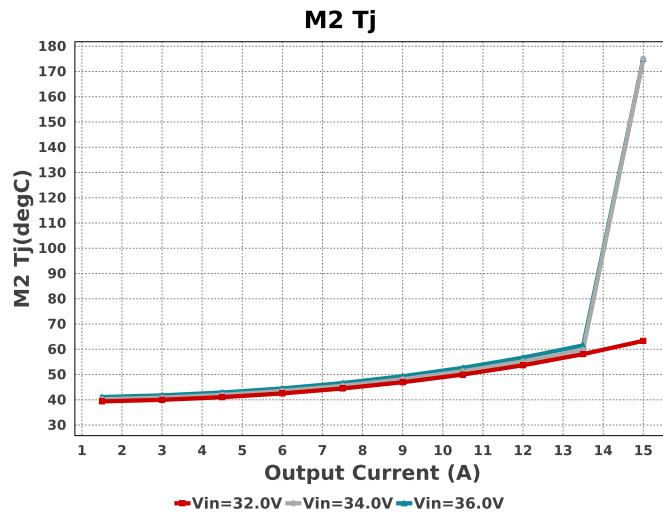
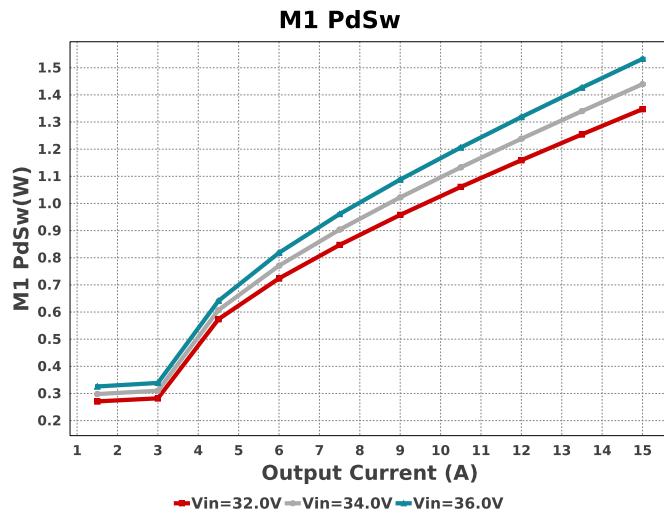
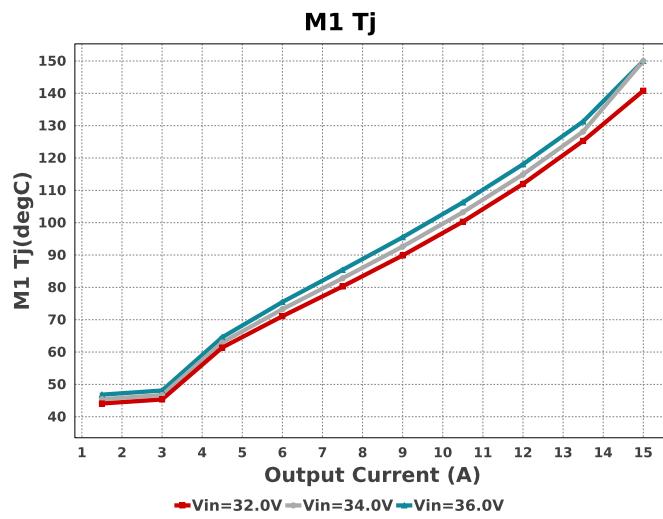
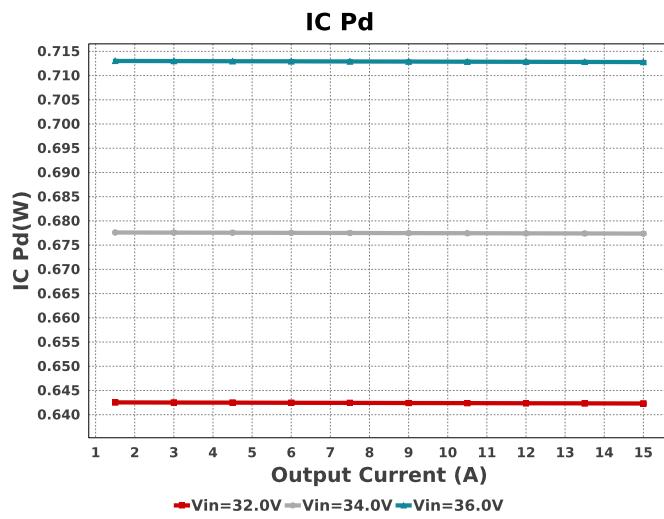
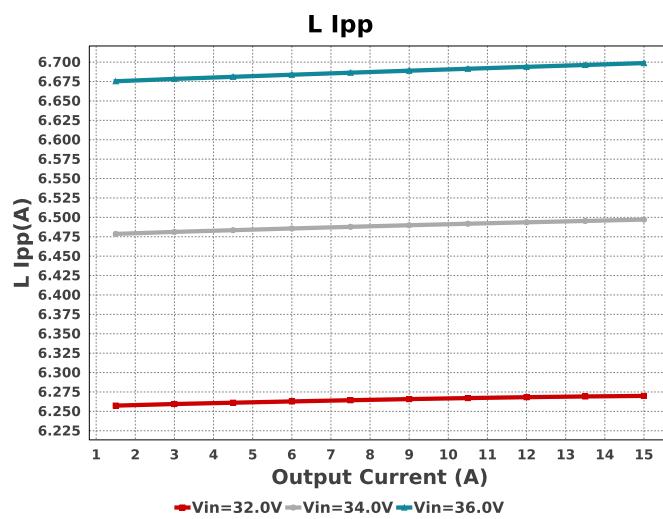
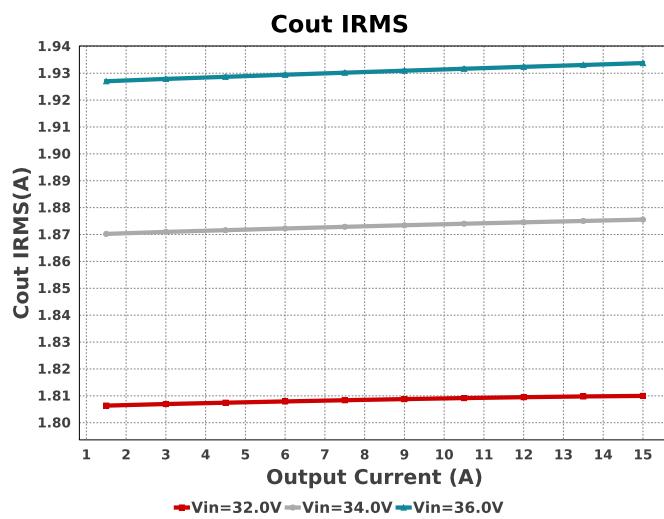
Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Cbst	MuRata	GRM188R61E104KA01D Series= X5R	Cap= 100.0 nF ESR= 30.0 mOhm VDC= 25.0 V IRMS= 0.0 A	1	\$0.01	■ 0603 5 mm ²
Ccomp1	MuRata	GRM155R71C822KA01D Series= X7R	Cap= 8.2 nF ESR= 1.0 mOhm VDC= 16.0 V IRMS= 0.0 A	1	\$0.01	■ 0402 3 mm ²
Ccomp2	TDK	CGA2B2X7R1H681K050BA Series= X7R	Cap= 680.0 pF ESR= 3.0778 Ohm VDC= 50.0 V IRMS= 257.63 mA	1	\$0.01	■ 0402 3 mm ²
Ccomp3	MuRata	GRM155R71H561KA01D Series= X7R	Cap= 560.0 pF ESR= 1.0 mOhm VDC= 50.0 V IRMS= 0.0 A	1	\$0.01	■ 0402 3 mm ²
Cilm	AVX	06031U6R8BAT2A Series= C0G/NP0	Cap= 6.8 pF VDC= 100.0 V IRMS= 0.0 A	1	\$0.05	■ 0603 5 mm ²
Cin	Taiyo Yuden	MSASU32MSB7475MPNA01 Series= X7R	Cap= 4.7 uF ESR= 6.456 mOhm VDC= 50.0 V IRMS= 3.147 A	1	\$0.15	■ 1210 15 mm ²
Cout	TDK	C3225X7R1H106M250AC Series= X7R	Cap= 10.0 uF ESR= 1.0 mOhm VDC= 50.0 V IRMS= 5.0 A	3	\$0.27	■ 1210 15 mm ²
Css	MuRata	GRM155R71C563KA88D Series= X7R	Cap= 56.0 nF ESR= 1.0 mOhm VDC= 16.0 V IRMS= 0.0 A	1	\$0.01	■ 0402 3 mm ²
Cvcc	TDK	C1005X5R1V225K050BC Series= X5R	Cap= 2.2 uF ESR= 1.0 mOhm VDC= 35.0 V IRMS= 0.0 A	1	\$0.06	■ 0402_065 3 mm ²

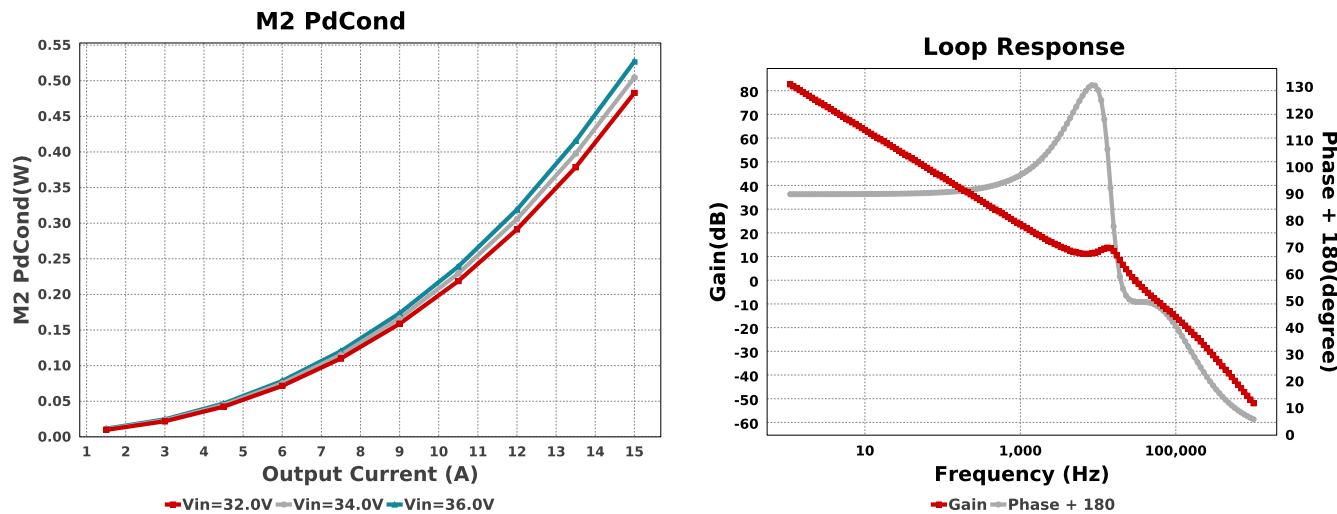
Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Cvin	TDK	CGA3E2X7R1H104K080AA Series= X7R	Cap= 100.0 nF ESR= 29.6 mOhm VDC= 50.0 V IRMS= 971.99 mA	1	\$0.01	■ 0603 5 mm ²
L1	Coilcraft	XAL1010-472MEB	L= 4.7 μ H 5.2 mOhm	1	\$1.71	 XAL1010 160 mm ²
M1	Texas Instruments	CSD19502Q5B	VdsMax= 80.0 V IdsMax= 100.0 Amps	1	\$0.74	DQK0006C 9 mm ²
M2	Texas Instruments	CSD18540Q5B	VdsMax= 60.0 V IdsMax= 100.0 Amps	1	\$0.75	 DNK0008A 56 mm ²
Rcomp1	Vishay-Dale	CRCW04022K10FKED Series= CRCW..e3	Res= 2.1 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	■ 0402 3 mm ²
Rcomp2	Vishay-Dale	CRCW040215R4FKED Series= CRCW..e3	Res= 15.4 Ohm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	■ 0402 3 mm ²
Rfbb	Vishay-Dale	CRCW04021K27FKED Series= CRCW..e3	Res= 1.27 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	■ 0402 3 mm ²
Rfbt	Yageo	RC0603FR-0718KL Series= ?	Res= 18.0 kOhm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	■ 0603 5 mm ²
Rilim	Vishay-Dale	CRCW0603976RFKEA Series= CRCW..e3	Res= 976.0 Ohm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	■ 0603 5 mm ²
Rpgood	Yageo	RC0603FR-0720KL Series= ?	Res= 20.0 kOhm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	■ 0603 5 mm ²
Rt	Vishay-Dale	CRCW040239K2FKED Series= CRCW..e3	Res= 39.2 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	■ 0402 3 mm ²
Ruv1	Vishay-Dale	CRCW0402158KFKED Series= CRCW..e3	Res= 158.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	■ 0402 3 mm ²
Ruv2	Yageo	RC0603FR-077K68L Series= ?	Res= 7.68 kOhm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	■ 0603 5 mm ²
Rvcc	Yageo	RC0603FR-0720KL Series= ?	Res= 20.0 kOhm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	■ 0603 5 mm ²
Rvin	Vishay-Dale	CRCW06032R10FKEA Series= CRCW..e3	Res= 2.1 Ohm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	■ 0603 5 mm ²
U1	Texas Instruments	LM25145RGYR	Switcher	1	\$0.95	 RGY0020B 25 mm ²











Operating Values

#	Name	Value	Category	Description
1.	Cin IRMS	7.183 A	Capacitor	Input capacitor RMS ripple current
2.	Cin Pd	333.13 mW	Capacitor	Input capacitor power dissipation
3.	Cout IRMS	1.934 A	Capacitor	Output capacitor RMS ripple current
4.	Cout Pd	1.246 mW	Capacitor	Output capacitor power dissipation
5.	IC Ipk	18.349 A	IC	Peak switch current in IC
6.	IC Pd	712.79 mW	IC	IC power dissipation
7.	IC Tj	54.805 degC	IC	IC junction temperature
8.	IC Tolerance	8.0 mV	IC	IC Feedback Tolerance
9.	ICThetaJA	34.8 degC/W	IC	IC junction-to-ambient thermal resistance
10.	Iin Avg	5.147 A	IC	Average input current
11.	Ipp percentage	44.658 %	Inductor	Inductor ripple current percentage (with respect to average inductor current)
12.	L Ipp	6.699 A	Inductor	Peak-to-peak inductor ripple current
13.	L Pd	1.189 W	Inductor	Inductor power dissipation
14.	M1 Pd	2.312 W	Mosfet	M1 MOSFET total power dissipation
15.	M1 PdCond	778.96 mW	Mosfet	M1 MOSFET conduction losses
16.	M1 PdSw	1.533 W	Mosfet	M1 MOSFET switching losses
17.	M1 Tj	150.0 degC	Mosfet	M1 MOSFET junction temperature
18.	M2 Pd	743.69 mW	Mosfet	M2 MOSFET total power dissipation
19.	M2 PdCond	527.11 mW	Mosfet	M2 MOSFET conduction losses
20.	M2 PdSw	216.58 mW	Mosfet	M2 MOSFET switching losses
21.	M2 Tj	175.0 degC	Mosfet	M2 MOSFET junction temperature
22.	Cin Pd	333.13 mW	Power	Input capacitor power dissipation
23.	Cout Pd	1.246 mW	Power	Output capacitor power dissipation
24.	IC Pd	712.79 mW	Power	IC power dissipation
25.	L Pd	1.189 W	Power	Inductor power dissipation
26.	M1 Pd	2.312 W	Power	M1 MOSFET total power dissipation
27.	M1 PdCond	778.96 mW	Power	M1 MOSFET conduction losses
28.	M1 PdSw	1.533 W	Power	M1 MOSFET switching losses
29.	M2 Pd	743.69 mW	Power	M2 MOSFET total power dissipation
30.	M2 PdCond	527.11 mW	Power	M2 MOSFET conduction losses
31.	M2 PdSw	216.58 mW	Power	M2 MOSFET switching losses
32.	Total Pd	5.3 W	Power	Total Power Dissipation
33.	BOM Count	27	System	Total Design BOM count
34.	Duty Cycle	33.788 %	System	Duty cycle
35.	Efficiency	97.14 %	System	Steady state efficiency
36.	FootPrint	380.0 mm ²	System	Total Foot Print Area of BOM components
37.	Frequency	255.102 kHz	System	Switching frequency
38.	Iout	15.0 A	System	Iout operating point
39.	Mode	FCCM	System	Conduction Mode
40.	Pout	180.0 W	System	Total output power
41.	Total BOM	\$5.39	System	Total BOM Cost

#	Name	Value	Category	Description
42.	Vin	36.0 V	System Information	Vin operating point
43.	Vin p-p	5.408 V	System Information	Peak-to-peak input voltage
44.	Vout	12.0 V	System Information	Operational Output Voltage
45.	Vout Actual	12.139 V	System Information	Vout Actual calculated based on selected voltage divider resistors
46.	Vout Tolerance	2.906 %	System Information	Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable
47.	Vout p-p	125.645 mV	System Information	Peak-to-peak output ripple voltage

Design Inputs

Name	Value	Description
Iout	15.0	Maximum Output Current
VinMax	36.0	Maximum input voltage
VinMin	32.0	Minimum input voltage
Vout	12.0	Output Voltage
base_pn	LM25145	Base Product Number
source	DC	Input Source Type
Ta	30.0	Ambient temperature

WEBENCH® Assembly

Component Testing

Some published data on components in datasheets such as Capacitor ESR and Inductor DC resistance is based on conservative values that will guarantee that the components always exceed the specification. For design purposes it is usually better to work with typical values. Since this data is not always available it is a good practice to measure the Capacitance and ESR values of C_{in} and C_{out} , and the inductance and DC resistance of L_1 before assembly of the board. Any large discrepancies in values should be electrically simulated in WEBENCH to check for instabilities and thermally simulated in WebTHERM to make sure critical temperatures are not exceeded.

Soldering Component to Board

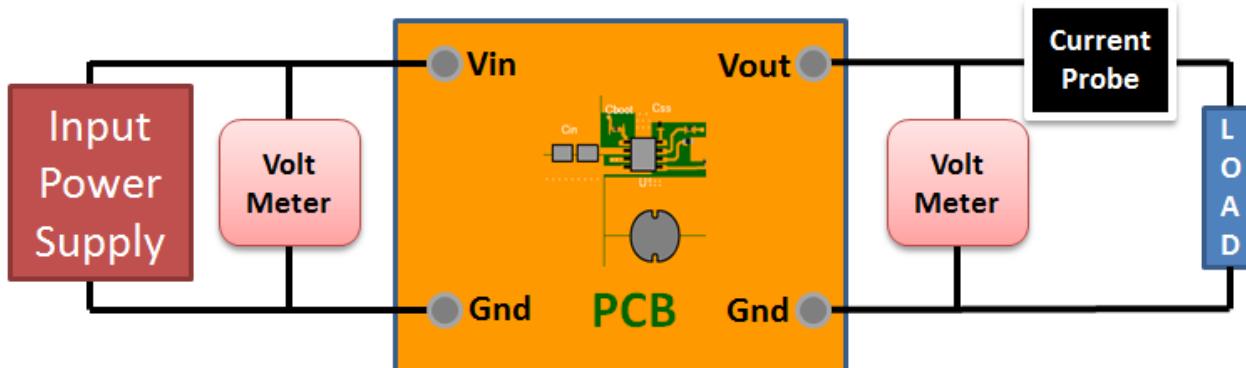
If board assembly is done in house it is best to tack down one terminal of a component on the board then solder the other terminal. For surface mount parts with large tabs, such as the DPAK, the tab on the back of the package should be pre-tinned with solder, then tacked into place by one of the pins. To solder the tab down to the board place the iron down on the board while resting against the tab, heating both surfaces simultaneously. Apply light pressure to the top of the plastic case until the solder flows around the part and the part is flush with the PCB. If the solder is not flowing around the board you may need a higher wattage iron (generally 25W to 30W is enough).

Initial Startup of Circuit

It is best to initially power up the board by setting the input supply voltage to the lowest operating input voltage 32.0V and set the input supply's current limit to zero. With the input supply off connect up the input supply to V_{in} and GND. Connect a digital volt meter and a load if needed to set the minimum I_{out} of the design from V_{out} and GND. Turn on the input supply and slowly turn up the current limit on the input supply. If the voltage starts to rise on the input supply continue increasing the input supply current limit while watching the output voltage. If the current increases on the input supply, but the voltage remains near zero, then there may be a short or a component misplaced on the board. Power down the board and visually inspect for solder bridges and recheck the diode and capacitor polarities. Once the power supply circuit is operational then more extensive testing may include full load testing, transient load and line tests to compare with simulation results.

Load Testing

The setup is the same as the initial startup, except that an additional digital voltmeter is connected between V_{in} and GND, a load is connected between V_{out} and GND and a current meter is connected in series between V_{out} and the load. The load must be able to handle at least rated output power + 50% (7.5 watts for this design). Ideally the load is supplied in the form of a variable load test unit. It can also be done in the form of suitably large power resistors. When using an oscilloscope to measure waveforms on the prototype board, the ground leads of the oscilloscope probes should be as short as possible and the area of the loop formed by the ground lead should be kept to a minimum. This will help reduce ground lead inductance and eliminate EMI noise that is not actually present in the circuit.



Design Assistance

1. Master key : 5CC8EEA08B0A1C6A35BBE75768F890F5[v1]
2. **LM25145 Product Folder** : <http://www.ti.com/product/lm25145> : contains the data sheet and other resources.

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